
**ADVANCED
POWER
TECHNOLOGY®**

APT5085CN	500V	8.0A	0.85Ω
APT4585CN	450V	8.0A	0.85Ω
APT501R1CN	500V	7.0A	1.10Ω
APT451R1CN	450V	7.0A	1.10Ω

POWER MOS IV™

N-CHANNEL ENHANCEMENT MODE HIGH VOLTAGE POWER MOSFETS

MAXIMUM RATINGS

 All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT 4585CN	APT 5085CN	APT 451R1CN	APT 501R1CN	UNIT
V _{DSS}	Drain-Source Voltage	450	500	450	500	Volts
I _D	Continuous Drain Current @ T _C = 25°C	8.0		7.0		Amps
I _{DM}	Pulsed Drain Current ①	32		28		
V _{GS}	Gate-Source Voltage	±30				Volts
P _D	Total Power Dissipation @ T _C = 25°C	125				Watts
	Linear Derating Factor	1.0				W/°C
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150				°C
T _L	Lead Temperature: 0.063" from Case for 10 Sec.	300				

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions / Part Number		MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage ($V_{GS} = 0V, I_D = 250 \mu A$)	APT5085CN / APT501R1CN	500			Volts
		APT4585CN / APT451R1CN	450			
$I_{D(ON)}$	On State Drain Current ^② ($V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max, $V_{GS} = 10V$)	APT5085CN / APT4585CN	8.0			Amps
		APT501R1CN / APT451R1CN	7.0			
$R_{DS(ON)}$	Drain-Source On-State Resistance ^② ($V_{GS} = 10V, 0.5 I_D$ [Cont.])	APT5085CN / APT4585CN			0.85	Ohms
		APT501R1CN / APT451R1CN			1.10	
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = V_{DSS}, V_{GS} = 0V$)				250	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_C = 125^\circ\text{C}$)				1000	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 30V, V_{DS} = 0V$)				± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 1.0mA$)		2		4	Volts

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			1.00	°C/W
$R_{\theta JA}$	Junction to Ambient			50	

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DYNAMIC CHARACTERISTICS

APT5085/4585/501R1/451R1CN

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{DC}	Drain-to-Case Capacitance	$f = 1 \text{ MHz}$		15	22	pF
C_{iss}	Input Capacitance	$V_{GS} = 0V$		740	950	
C_{oss}	Output Capacitance	$V_{DS} = 25V$		167	234	
C_{rss}	Reverse Transfer Capacitance	$f = 1 \text{ MHz}$		63	94	
Q_g	Total Gate Charge ③	$V_{GS} = 10V$		33	55	nC
Q_{gs}	Gate-Source Charge	$V_{DD} = 0.5 V_{DSS}$		5.6	8	
Q_{gd}	Gate-Drain ("Miller") Charge	$I_D = I_D [\text{Cont.}] @ 25^\circ\text{C}$		16	24	
$t_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15V$		9	18	ns
t_r	Rise Time	$V_{DD} = 0.5 V_{DSS}$		14	28	
$t_{d(off)}$	Turn-off Delay Time	$I_D = I_D [\text{Cont.}] @ 25^\circ\text{C}$		35	52	
t_f	Fall Time	$R_G = 1.8\Omega$		11	22	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)	APT5085CN / APT4585CN		8	Amps
		APT501R1CN / APT451R1CN		7	
I_{SM}	Pulsed Source Current ① (Body Diode)	APT5085CN / APT4585CN		32	
		APT501R1CN / APT451R1CN		28	
V_{SD}	Diode Forward Voltage ② ($V_{GS} = 0V$, $I_S = -I_D [\text{Cont.}]$)			1.3	Volts
t_{rr}	Reverse Recovery Time ($I_S = -I_D [\text{Cont.}]$, $dI_S/dt = 100A/\mu s$)	108	216	432	ns
Q_{rr}	Reverse Recovery Charge ($I_S = -I_D [\text{Cont.}]$, $dI_S/dt = 100A/\mu s$)	1.2	2.5	5.0	μC

SAFE OPERATING AREA CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
SOA1	Safe Operating Area	$V_{DS} = 0.4 V_{DSS}$, $I_{DS} = P_D / 0.4 V_{DSS}$, $t = 1 \text{ Sec.}$	125			Watts
SOA2	Safe Operating Area	$I_{DS} = I_D [\text{Cont.}]$, $V_{DS} = P_D / I_D [\text{Cont.}]$, $t = 1 \text{ Sec.}$	125			
I_{LM}	Inductive Current Clamped	APT5085CN / APT4585CN	32			Amps
		APT501R1CN / APT451R1CN	28			

① Repetitive Rating: Pulse width limited by maximum junction temperature. See Transient Thermal Impedance Curve. (Fig.1)

② Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

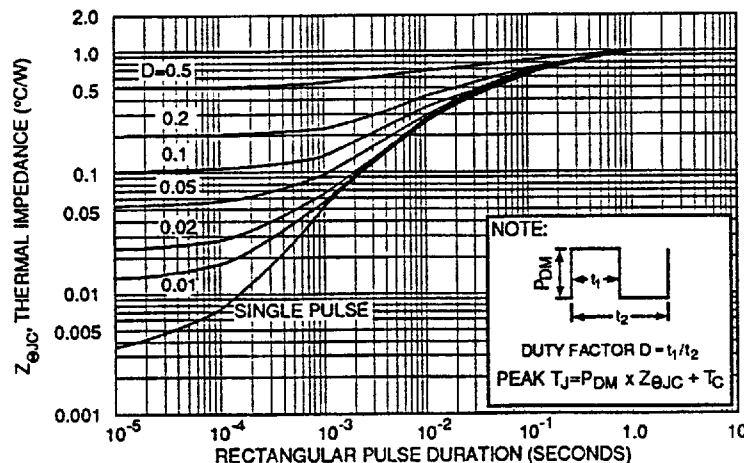


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

APT5085/4585/501R1/451R1CN

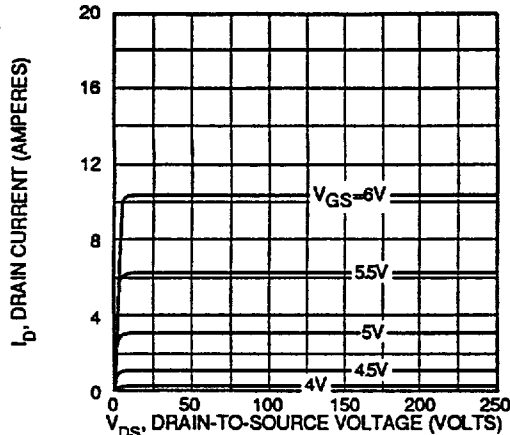


FIGURE 2, TYPICAL OUTPUT CHARACTERISTICS

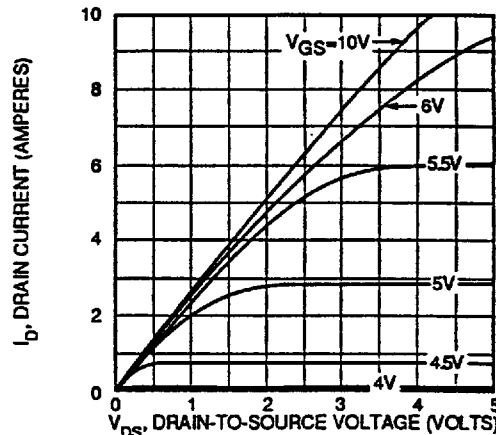


FIGURE 3, TYPICAL OUTPUT CHARACTERISTICS

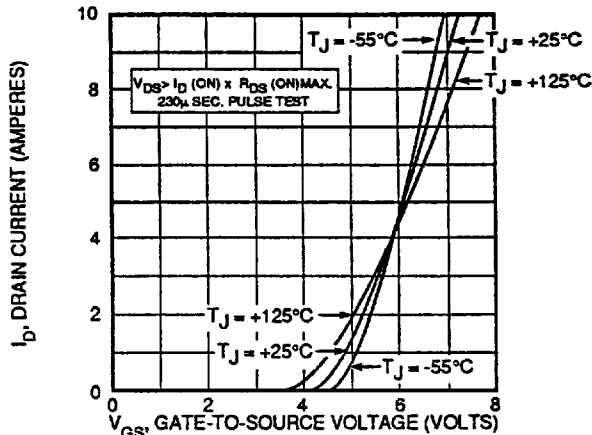


FIGURE 4, TYPICAL TRANSFER CHARACTERISTICS

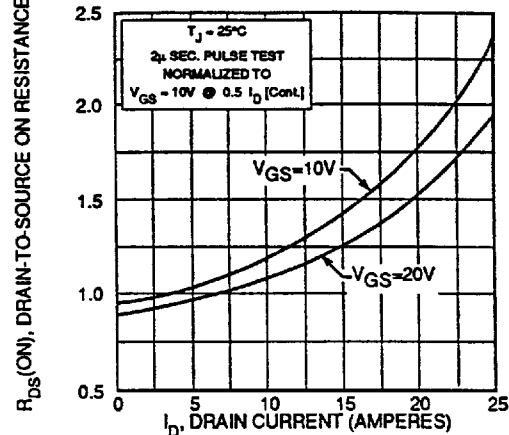


FIGURE 5, $R_{DS(ON)}$ vs DRAIN CURRENT

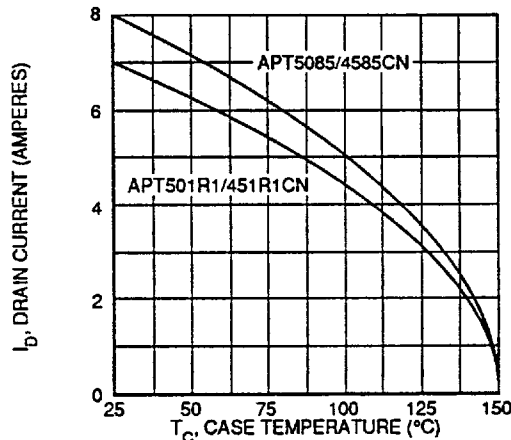


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

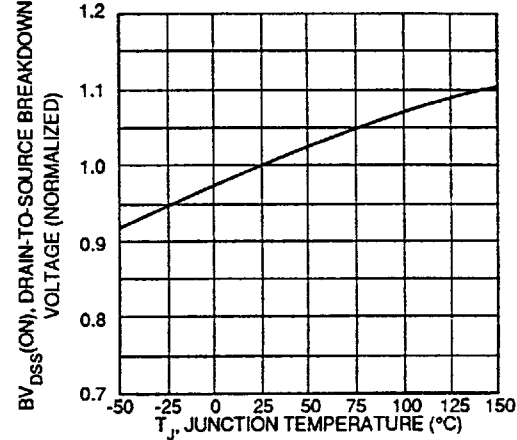


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

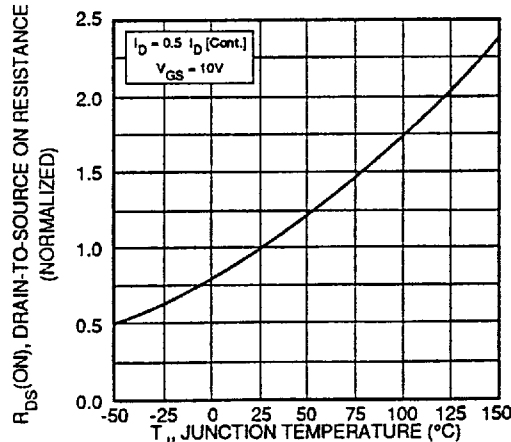


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

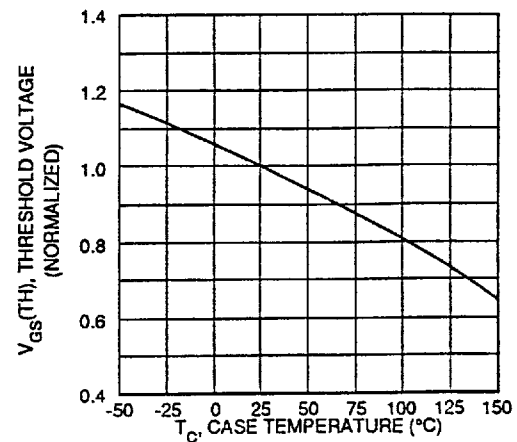
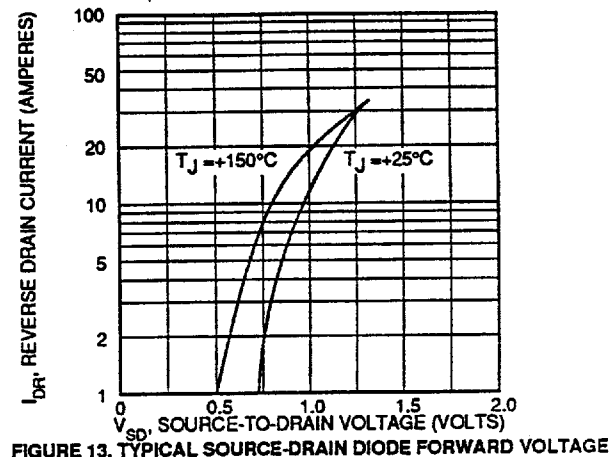
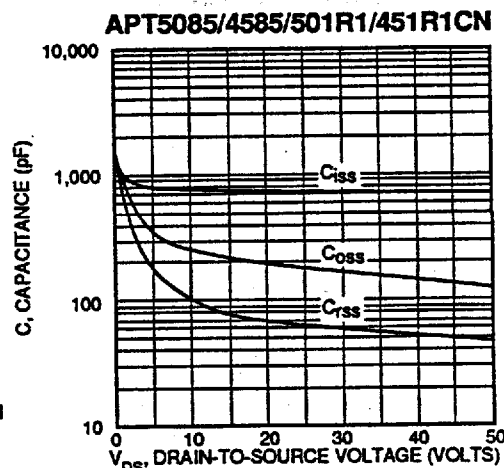
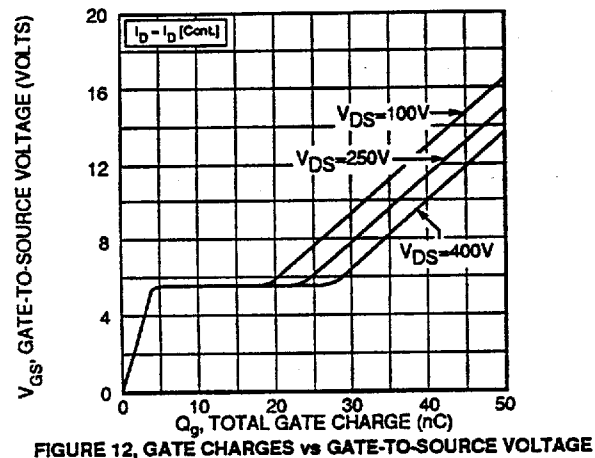
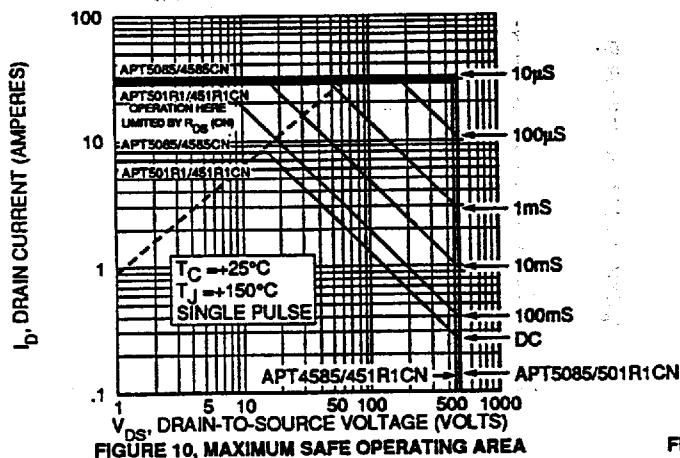


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE



TO-254AA Package Outline

